Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.					This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.											
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ous Materi	ials and Mfg Information					
Supplier	Information															
Company name* Company unique ID					Unique ID Authority					Response Date*						
onsemi													2023-06-08			
Contact Name Title - Contact				et	J			Phone - Contact*					Email - Contact*			
Product-E	nv-Stewards		Product Envi	o Compliance			NA				Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - R				tle - Representative			Phone - Representative*				Email - Representative*					
Product-E	nv-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Dat	e Versi	on 1	Manufacturing Site		Wei	ght*	UOM	Unit Type	
		AS02600 A0-CR1	AS0260CSSC28SUK 2 MP 1/6 CIS SOC A0-CR1				2023-06-08		CP2		34.3	9004	mg	Each		
Manufac	turing Proccess Informat	ion														
-	Terminal Plating / Grid Array Material Terminal Plating / Grid Array Material		erminal Base Alloy J-S		J-STD-020 MSL	_ Rating	Peak Pro	ocess Body Temperature		e Max Time at Peak Temperat		Temperature	Numbe	er of Reflow Cyc	eles	
	SnAgCu		CU Alloy 6		6		260		C	30		seconds	3			
Comments																
													·			
or more in	nformation regarding material o	composition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appli											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.73	mg		Misc.	proprietary data		0.0218	mg
			Supplier	Silicon (Si)	7440-21-3		5.6515	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0567	mg
Die Attach	0.53	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.318	mg
			Supplier	Epoxy resins	129915-35-1		0.106	mg
			Supplier	Acrylic resins	Proprietary Data		0.106	mg
Electrode	0.58	mg	Supplier	Titanium (Ti)	7440-32-6		0.0003	mg
			В	Nickel (Ni)	7440-02-0		0.3453	mg
			Supplier	Gold (Au)	7440-57-5		0.0139	mg
			Supplier	Copper (Cu)	7440-50-8		0.0087	mg
			Supplier	Aluminum (Al)	7429-90-5		0.2117	mg
Glass Lid /Cap	24.24	mg	Supplier	Boron Trioxide (B2O3)	1303-86-2		3.4421	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		12.12	mg
			Supplier	Barium Monoxide (BaO)	1304-28-5		5.8176	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		2.6664	mg
			Supplier	Calcium Monoxide (CaO)	1305-78-8		0.0242	mg
			В	Arsenic Trioxide (As2O3)	1327-53-3		0.1697	mg
Lid Attach	4.0E-5	mg		Photoinitiator	proprietary data		0	mg
			Supplier	Epoxy Prepolymer	Proprietary Data		0	mg
Solder Ball	0.84	mg	Supplier	Silver (Ag)	7440-22-4		0.0643	mg
			Supplier	Tin (Sn)	7440-31-5		0.7568	mg
			Supplier	Copper (Cu)	7440-50-8		0.0189	mg
Substrate and Solder Mask	2.47	mg	Supplier	Silica crystalline	14808-60-7, 14464- 46-1		0.247	mg
			Supplier	Cured Resin of Solder Mask	Proprietary Data		1.1732	mg
			Supplier	Bismaleimide Triazine resin	Proprietary Data		1.0498	mg